

3-TERMINAL POSITIVE ADJUSTABLE REGULATOR

DESCRIPTION

The μ PC317 is an adjustable 3-terminal positive voltage regulator, which has 1.5 A capable for the output current. The output voltage can be set any value between 1.3 V and 30 V by two external resistors.

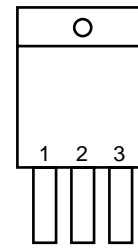
FEATURES

- Output current excess of 1.5 A
- On-chip some protection circuit (over current protection, SOA protection and thermal shut down).

PIN CONFIGURATION (Marking Side)

3-pin plastic SIP (MP-45G)

μ PC317HF

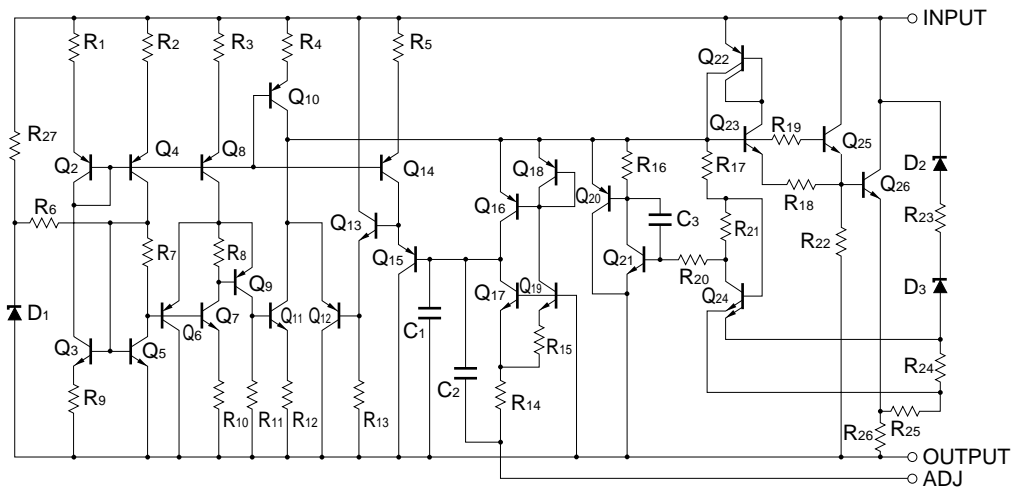


1 : ADJ
2 : OUTPUT
3 : INPUT

ORDERING INFORMATION

Part Number	Package
μ PC317HF	3-pin plastic SIP (MP-45G) (isolated TO-220)

EQUIVALENT CIRCUIT



The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified.)

Parameter	Symbol	Rating	Unit
Input-Output Voltage Differential	V _{IN} – V _O	–0.3 to +40	V
Total Power Dissipation (T _C = 25°C)	P _T	15 ^{Note}	W
Operating Ambient Temperature	T _A	–20 to +80	°C
Operating Junction Temperature	T _J	–20 to +150	°C
Storage Temperature	T _{stg}	–65 to +150	°C
Thermal Resistance (junction to case)	R _{th (J-C)}	5	°C/W
Thermal Resistance (junction to ambient)	R _{th (J-A)}	65	°C/W

Note Internally limited.

When operating junction temperature rise up to 150°C (≤200°C), the internal circuit shutdown output voltage.

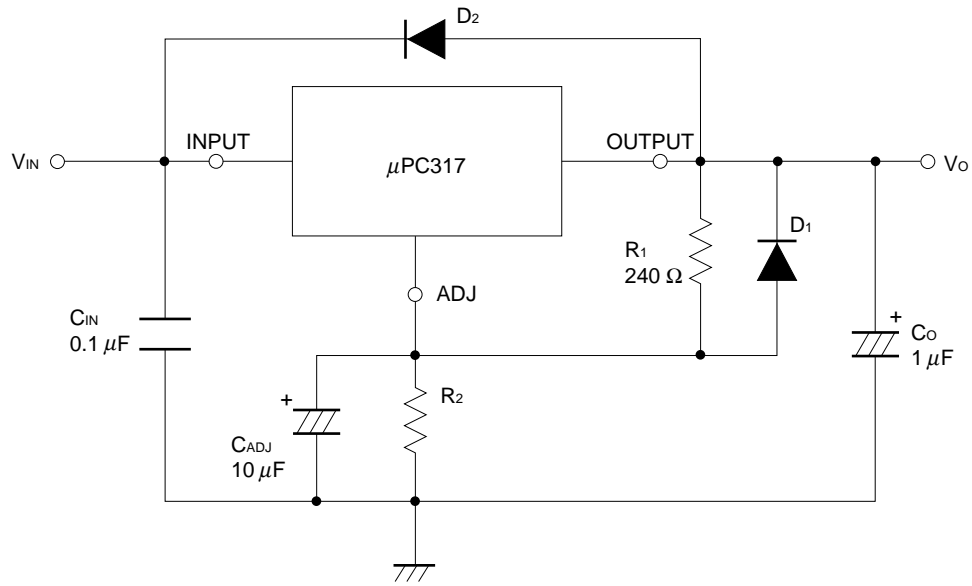
Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Input-Output Voltage Differential	V _{IN} – V _O	3		38.7	V
Input Voltage	V _{IN}	4.3		40	V
Output Voltage	V _O	1.3		30	V
Output Current	I _O	0.01		1.5	A
Operating Junction Temperature	T _J	–20		+125	°C

Caution The recommended operating range may be exceeded without causing any problems provided that the absolute maximum ratings are not exceeded. However, if the device is operated in a way that exceeds the recommended operating conditions, the margin between the actual conditions of use and the absolute maximum ratings is small, and therefore thorough evaluation is necessary. The recommended operating conditions do not imply that the device can be used with all values at their maximum values.

TYPICAL CONNECTION



Remark R₁, R₂ : Resistor to set the output voltage.

$$V_o = \left(1 + \frac{R_2}{R_1}\right) \cdot V_{REF} + I_{ADJ} \cdot R_2 \approx \left(1 + \frac{R_2}{R_1}\right) \cdot V_{REF}$$

V _o (V)	R ₂ (Ω : TYP.)
1.25	0
2.5	240
5.0	720
12	2064
24	4368
30	5520

C_{IN} : Need to stop the oscillation for the long input wiring length.

C_O : Need to stop the oscillation for the long output wiring length.

Improve the transient stability of the output voltage when the load current is suddenly changed.

C_{ADJ} : Improve the ripple rejection and the oscillate rejection.

D₁ : Protect against C_{ADJ} from output short.

D₂ : Need for V_{IN} < V_O.

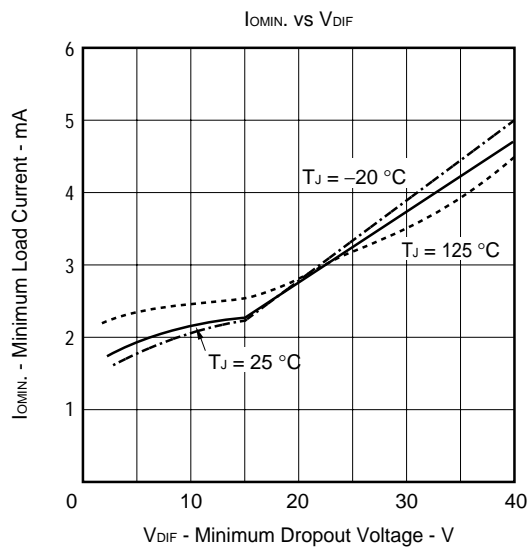
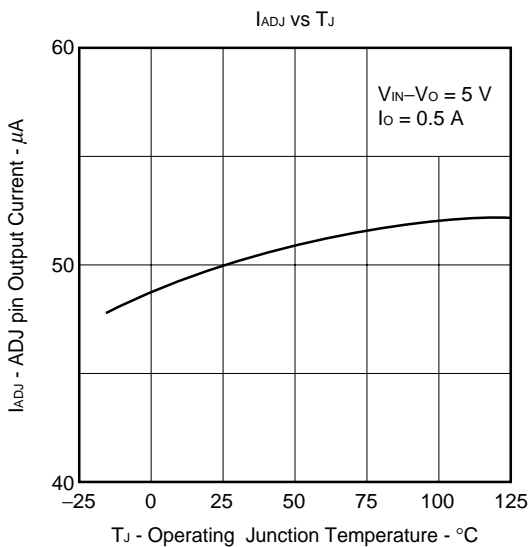
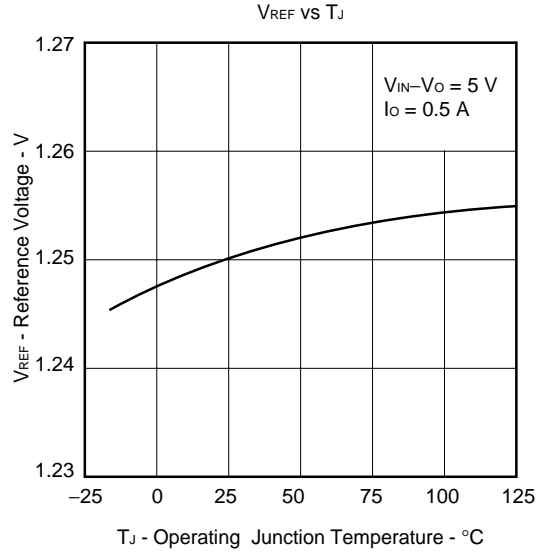
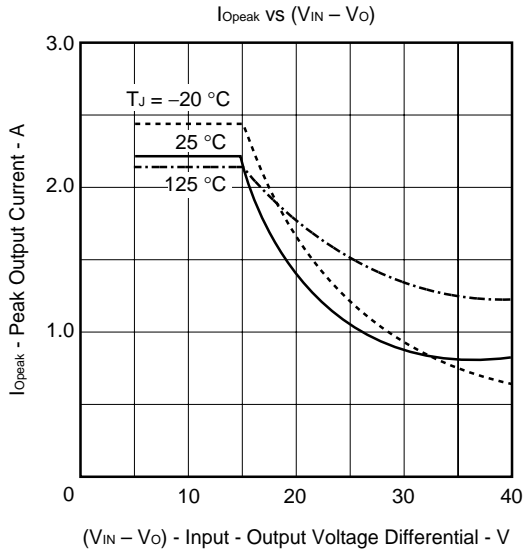
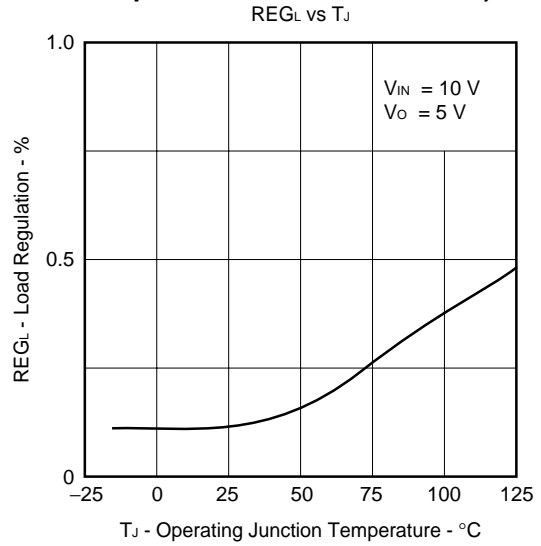
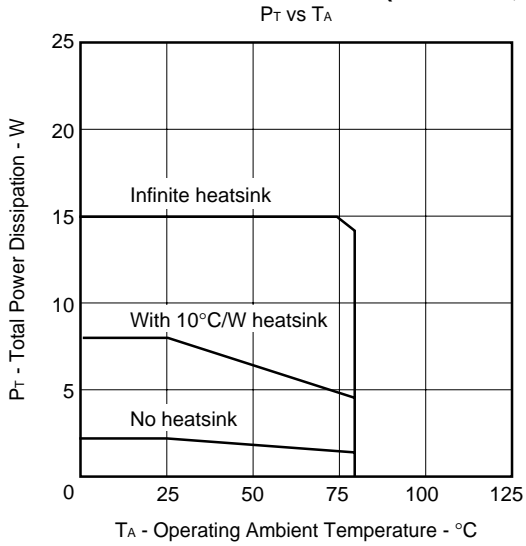
ELECTRICAL CHARACTERISTICS

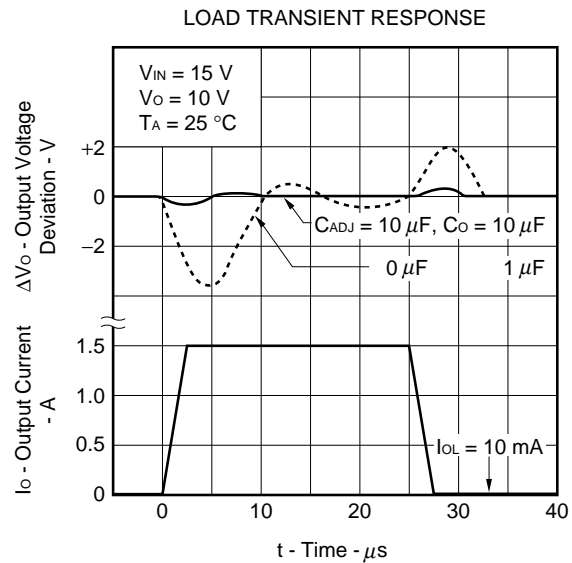
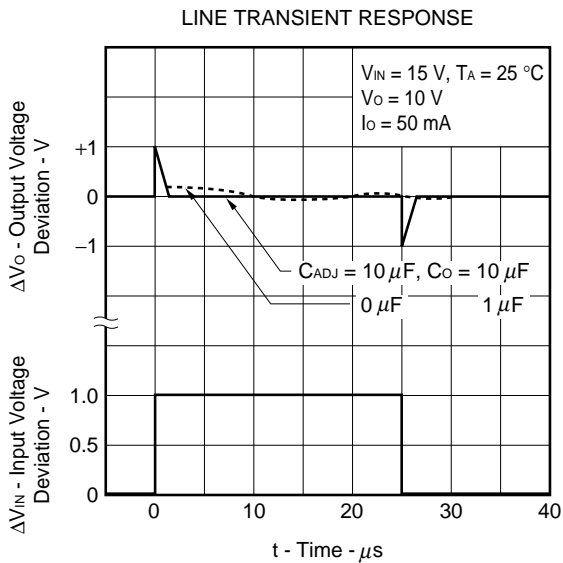
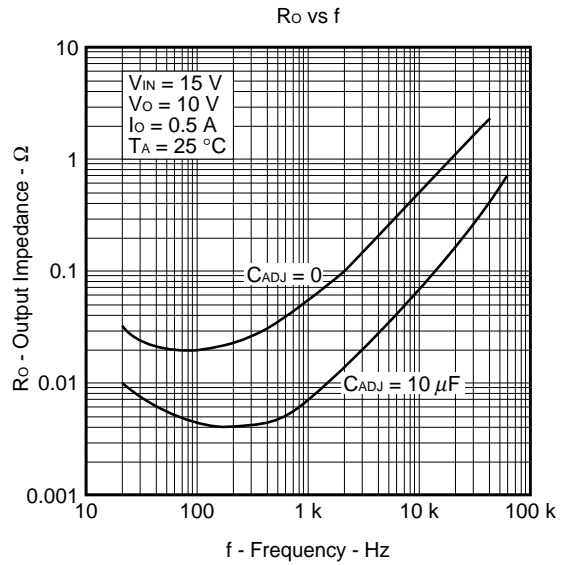
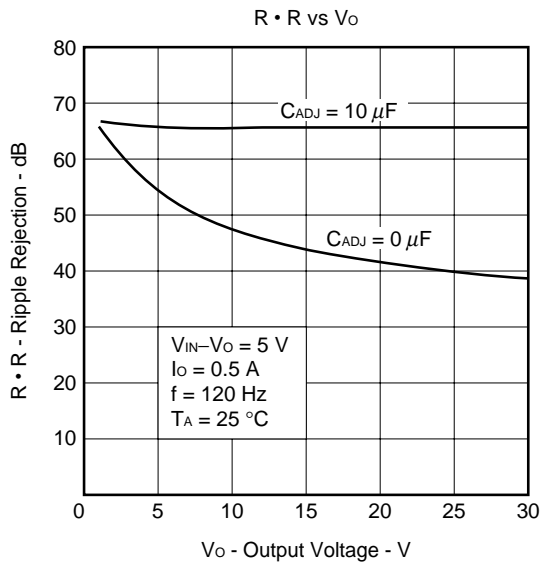
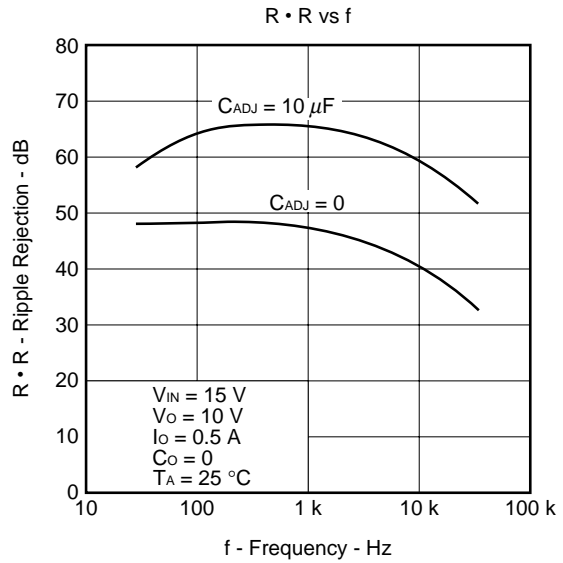
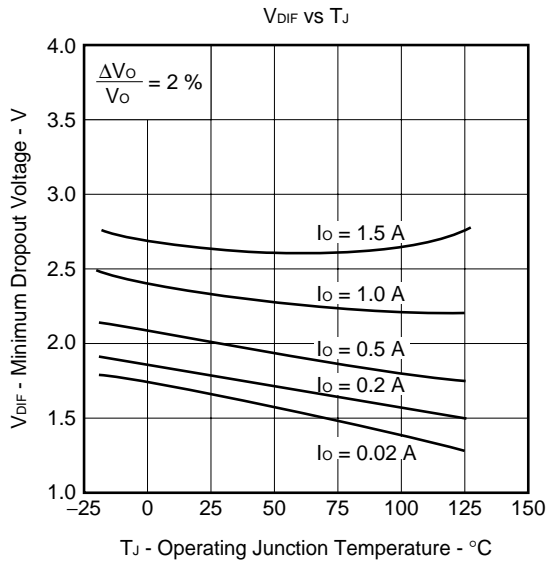
($V_{IN} - V_O = 5\text{ V}$, $I_O = 0.5\text{ A}$, $0^\circ\text{C} \leq T_J \leq +125^\circ\text{C}$, unless otherwise specified.)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Line Regulation	REG _{IN}	$T_A = 25^\circ\text{C}$, $3\text{ V} \leq (V_{IN} - V_O) \leq 40\text{ V}$, $I_O = 0.1\text{ A}$ ^{Note}		0.01	0.04	%/V	
		$3\text{ V} \leq (V_{IN} - V_O) \leq 40\text{ V}$, $I_O = 0.1\text{ A}$ ^{Note}		0.02	0.07	%/V	
Load Regulation	REG _L	$T_J = 25^\circ\text{C}$	$V_O \leq 5\text{ V}$		5	25	mV
		$10\text{ mA} \leq I_O \leq 1.5\text{ A}$ ^{Note}	$V_O \geq 5\text{ V}$		0.1	0.5	%
		$10\text{ mA} \leq I_O \leq 1.5\text{ A}$ ^{Note}	$V_O \leq 5\text{ V}$		20	70	mV
			$V_O \geq 5\text{ V}$		0.3	1.5	%
Thermal Regulation	REG _{TH}	$T_A = 25^\circ\text{C}$, $0.2\text{ ms} \leq t \leq 20\text{ ms}$		0.01	0.07	%/W	
ADJ pin Output Current	I _{ADJ}			50	100	μA	
I _{ADJ} Change	ΔI _{ADJ}	$10\text{ mA} \leq I_O \leq 1.5\text{ A}$, $P_T \leq 15\text{ W}$		0.4	5	μA	
Reference Voltage	V _{REF}	$10\text{ mA} \leq I_O \leq 1.5\text{ A}$, $P_T \leq 15\text{ W}$	1.20	1.25	1.30	V	
Temperature Stability of V _{REF}	ΔV _{REF} /ΔT			0.7		%	
Minimum Load Current	I _{OMIN.}	$V_{IN} - V_O = 40\text{ V}$		4.7	10	mA	
Peak Output Current	I _{Opeak}	$5\text{ V} \leq (V_{IN} - V_O) \leq 15\text{ V}$	1.5	2.2	2.9	A	
		$V_{IN} - V_O = 40\text{ V}$	0.15	0.8		A	
Output Noise Voltage (RMS)	V _n	$T_A = 25^\circ\text{C}$, $10\text{ Hz} \leq f \leq 10\text{ kHz}$		0.001		%	
Ripple Rejection	R • R	$T_A = 25^\circ\text{C}$, $\Delta V_{IN} = 1\text{ V}_{r.m.s}$ $f = 120\text{ Hz}$, $V_O = 10\text{ V}$	C _{ADJ} = 0		48		dB
			C _{ADJ} = 10 μF	56	65		dB

Note Measured at constant junction temperature, using pulse testing with a low duty cycle.
PW = 10 ms, Duty Cycle ≤ 2 %

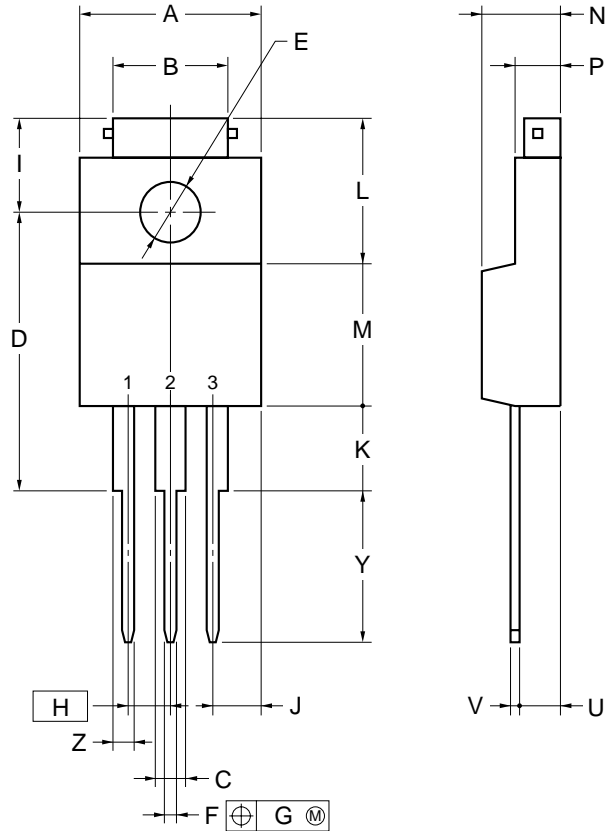
TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified. Reference Values.)





PACKAGE DRAWING

3PIN PLASTIC SIP (MP-45G)



NOTE

Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	10.0±0.2
B	7.0±0.2
C	1.50±0.2
D	17.0±0.3
E	φ3.3±0.2
F	0.75±0.10
G	0.25
H	2.54 (T.P.)
I	5.0±0.3
J	2.46±0.2
K	5.0±0.2
L	8.5±0.2
M	8.5±0.2
N	4.5±0.2
P	2.8±0.2
U	2.4±0.5
V	0.65±0.10
Y	8.9±0.7
Z	1.30±0.2

P3HF-254B-4

RECOMMENDED SOLDERING CONDITIONS

When soldering these products, it is highly recommended to observe the conditions as shown below. If other soldering processes are used, or if the soldering is performed under different conditions, please make sure to consult with our sales offices.

For more details, refer to our document "**SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E)**".

Type of Through-hole Devices

μPC317HF: 3-pin plastic SIP (MP-45G)(isolated TO-220)

Process	Conditions
Wave soldering (only to leads)	Solder temperature: 260°C or below, Flow time: 10 seconds or less.
Partial heating method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (per each lead).

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

REFERENCE DOCUMENTS

QUALITY GRADES ON NEC SEMICONDUCTOR DEVICES	C11531E
SEMICONDUCTOR DEVICE MOUNTING THCHNOLOGY MANUAL	C10535E
SEMICONDUCTORS SELECTION GUIDE – Products and Packages – (CD-ROM)	X13769X
SEMICONDUCTORS SELECTION GUIDE	X10679E
NEC SEMICONDUCTOR DEVICE RELIABILITY/QUALITY CONTROL SYSTEM	IEI-1212
-THREE TERMINAL REGULATOR	

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 - Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
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